505785136 11/21/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HENDRIK OLDENKAMP	09/19/2019

RECEIVING PARTY DATA

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City:	NIESTETAL
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16563071

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ATTORNEY DOCKET NUMBER:	SMAP216WOUS
NAME OF SUBMITTER:	THOMAS G. ESCHWEILER
SIGNATURE:	/Thomas G. Eschweiler/
DATE SIGNED:	11/21/2019

Total Attachments: 3

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PATENT 505785136 REEL: 051074 FRAME: 0958

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):
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Netherlands

Assignee:
SMA Solar Technology AG
Sonnenallee 1
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Germany

AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled "SOLAR MODULE, CONNECTION SYSTEM AND SOLAR MODULE SYSTEM" for which:

	a n	on-provisional application for United States Letters Patent:	
		was executed on even date preparatory to filing (each inventor should	
		sign this Assignment on the same day as he/she signs the Declaration	
		and Power of Attorney); or	
		was filed on and accorded U.S. Serial No; or	
☐ I hereby authorize and request my attorney associated with Custo			
		29393, to insert on the designated lines below the filing date and	
		application number of said application when known:	
		U.S. Serial No.	
		filed on	

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Docket No. SMAP216WOUS

WHEREAS, ASSIGNEE (listed above), a corporation of the Federal Republic of Germany is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries:

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and assigns, the entire right, title and interest in and to said invention and improvements, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, re-examinations and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

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19 Sept 2019

Name 1st Inventor Hendrik Oldenkamp

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